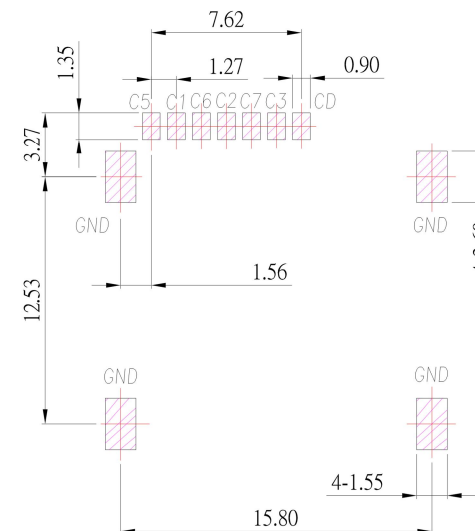
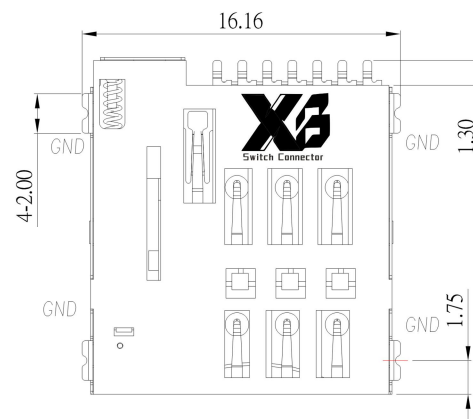
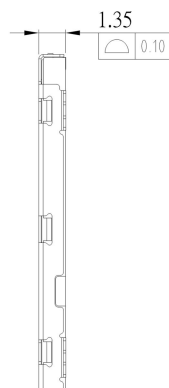
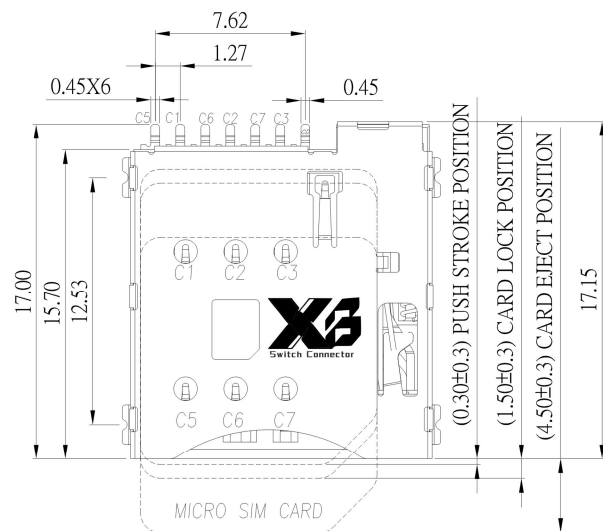
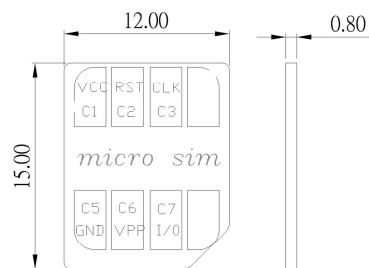
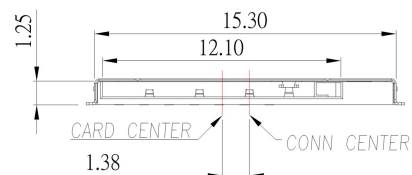
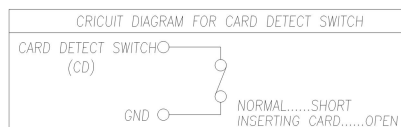




PCB LAYOUT



SIM pin Assignment	
PIN#	Name
C1	VCC
C2	RST
C3	CLK
C5	GND
C6	VPP
C7	I/O



Material:

- 1.Housing: LCP
- 2.Contact: Copper Alloy
- 3.Shell: Stainless Steel

Finish:

- 1.Contact: Plated Gold in Mating Area ;
Gold Plated on Solder Balls ;
Nickel under plated overall
- 2.Shell: Nickel under Plated surface layer



东莞市溪榜电子有限公司
DONG GUAN XI BANG ELECTRONICS CO., LTD.

TOLERANCE UNLESS
OTHERWISE STATED :

Up to 5	±0.2
Above 5 ~ 15	±0.3
Above 15 ~ 30	±0.4
Above 30 ~ 50	±0.5
Angle	±0.3°

3RD.
ANGEL'S



UNITS

MM

DRAWN BY: Jack Lu
CHECKED BY: Jacky Chen
APPROVED BY: Tony Kao

DATE: 09/28/18
DATE: 09/28/18
DATE: 09/28/18

MAT'L	TITLE	CONNECTOR
FINISH	MODLE	MICRO SIM PUSH. 7PIN H1.35
SCALE	DWG NO.	MSIM-135A-01BR-S304
SHEET NO.	PART NO.	MSIM-135A-01BR-S304

1 : 1

1 of 1

SIZE A4
VER R

ITEM NO.	DESCRIPTION	DRAWN	DATE
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